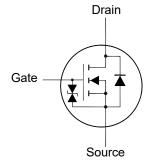
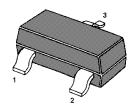
N-Channel Enhancement Mode MOSFET

Features

- AEC-Q101 Qualified
- · Advanced trench cell design
- Built-in G-S Protection Diode
- Halogen and Antimony Free(HAF), RoHS compliant
- Typical ESD Protection HBM Class 2

Classification	Voltage Range(V)
0A	< 125
0B	125 to < 250
1A	250 to < 500
1B	500 to < 1000
1C	1000 to < 2000
2	2000 to < 4000
3A	4000 to < 8000
3B	≥ 8000





1. Gate 2. Source 3. Drain SOT-23 Plastic Package

Applications

- Portable appliances
- Power management

Absolute Maximum Ratings(at Ta = 25°C unless otherwise specified)

Parameter	Symbol	Value	Unit	
Drain-Source Voltage	V_{DS}	30	V	
Gate-Source Voltage	V_{GS}	± 20	V	
Continuous Drain Current	I_D	3.6	Α	
Pulsed Drain Current 1)	I _{DM}	18	Α	
Lotal Power Dissination 4	≤ 10 s Steady State	P _{tot}	1.4 1	W
Operating Junction and Storage Temperature Rang	T_j , T_{stg}	- 55 to + 150	°C	

Thermal Characteristics

Parameter	Symbol	Max.	Unit	
Thermal Resistance from Junction to Ambient ²⁾	t ≤ 10 s Steady State	$R_{\theta JA}$	89 125	°C/W

¹⁾ Pulse Test: Pulse Width ≤ 100 μs, Duty Cycle ≤ 2%,Repetitive rating, pulse width limited by junction temperature $T_{J(MAX)}$ =150°C.



²⁾ Device mounted on FR-4 substrate PC board, 2oz copper, with 1-inch square copper plate in still air.

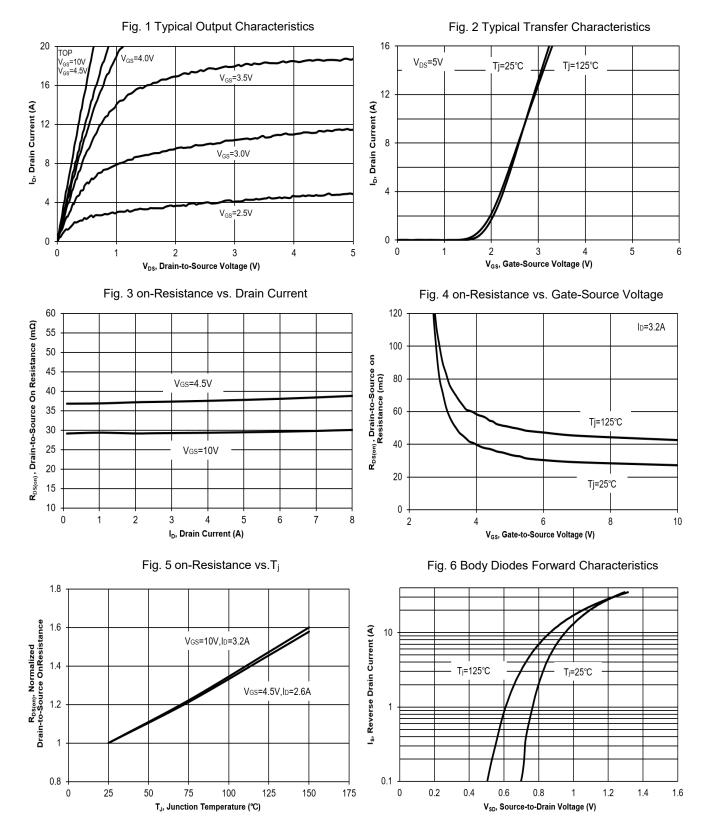
MKA03N095LZK-AH

Characteristics at T_a = 25°C unless otherwise specified

Parameter	Symbol	Min.	Тур.	Max.	Unit
STATIC PARAMETERS					
Drain-Source Breakdown Voltage at I _D = 250 μA	V _{(BR)DSS}	30	-	-	V
Zero Gate Voltage Drain Current at V _{DS} = 24 V	I _{DSS}	-	-	1	μΑ
Gate-Source Leakage at $V_{GS} = \pm 16 \text{ V}$	Igss	-	-	± 10	μA
Gate-Source Threshold Voltage at V_{DS} = V_{GS} , I_D = 250 μA	V _{GS(th)}	1	-	2.2	V
Drain-Source On-State Resistance at V_{GS} = 10 V, I_D = 3.2 A at V_{GS} = 4.5 V, I_D = 2.6 A	R _{DS(ON)}	- -	-	65 95	mΩ
DYNAMIC PARAMETERS					
Forward Transconductance at $V_{DS} = 5 \text{ V}$, $I_D = 3 \text{ A}$	G fs	-	6.3	-	S
Gate Resistance at $V_{DS} = 0 \text{ V}$, $V_{GS} = 0 \text{ V}$, $f = 1 \text{ MHz}$	Rg	-	4.4	-	Ω
Input Capacitance at V_{DS} = 15 V, V_{GS} = 0 V, f = 1 MHz	Ciss	-	313	-	pF
Output Capacitance at V_{DS} = 15 V, V_{GS} = 0 V, f = 1 MHz	Coss	-	42	-	pF
Reverse Transfer Capacitance at V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz	Crss	-	22	-	pF
Total Gate Charge at V_{DS} = 15 V, I_D = 3 A, V_{GS} = 10 V at V_{DS} = 15 V, I_D = 3 A, V_{GS} = 4.5 V	Qg	- -	6.7 3.2	- -	nC
Gate to Source Charge at V_{DS} = 15 V, I_D = 3 A, V_{GS} = 10 V	Q _{gs}	1	1.1	-	nC
Gate to Drain Charge at V_{DS} = 15 V, I_D = 3 A, V_{GS} = 10 V	Q_{gd}	-	1.1	-	nC
Turn-On Delay Time at V_{DS} = 15 V, I_D = 3 A, V_{GS} = 10 V, R_G = 3.9 Ω	t _{d(on)}	-	6	-	ns
Turn-On Rise Time at V_{DS} = 15 V, I_D = 3 A, V_{GS} = 10 V, R_G = 3.9 Ω	tr	-	13	-	ns
Turn-Off Delay Time at V_{DS} = 15 V, I_D = 3 A, V_{GS} = 10 V, R_G = 3.9 Ω	t _{d(off)}	-	8	-	ns
Turn-Off Fall Time at V_{DS} = 15 V, I_D = 3 A, V_{GS} = 10 V, R_G = 3.9 Ω	t _f	-	3	-	ns
Body-Diode PARAMETERS					
Drain-Source Diode Forward Voltage at Is = 3 A	V _{SD}	-	-	1.2	V
Body-Diode Continuous Current	Is	-	-	3.6	Α
Body Diode Reverse Recovery Time at Is = 3 A, di/dt = 100 A / µs	t _{rr}	-	5.4	-	nS
Body Diode Reverse Recovery Charge at Is = 3 A, di/dt = 100 A / µs	Q _{rr}	ı	1.8	-	nC



Electrical Characteristics Curves





Electrical Characteristics Curves



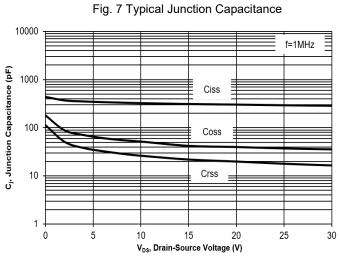


Fig. 8 Drain-Source Leakage Current vs. T_j

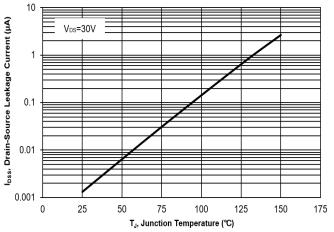


Fig. 9 $V_{(BR)DSS}$ vs. Junction Temperature

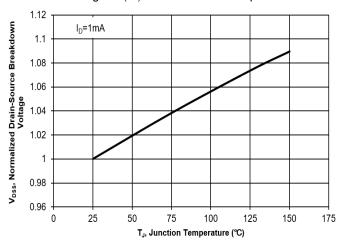


Fig. 10 Gate Threshold Variation vs. T_i

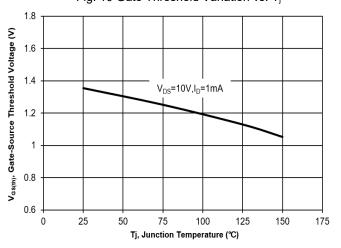
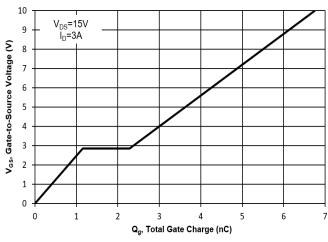
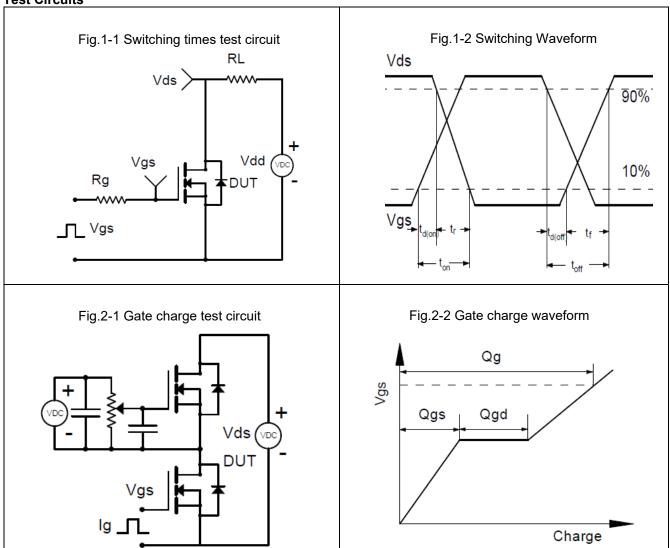


Fig. 11 Gate Charge





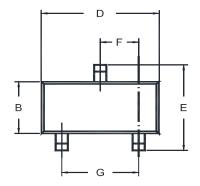
Test Circuits

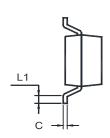


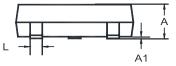


Package Outline (Dimensions in mm)

SOT-23

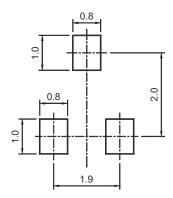






Unit	Α	A1	В	С	D	Е	F	G	L	L1
mana	1.20	0.100	1.40	0.19	3.04	2.6	1.02	2.04	0.51	0.2
mm	0.89	0.013	1.20	0.08	2.80	2.2	0.89	1.78	0.37	MIN

Recommended Soldering Footprint



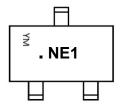
Packing information

Tucking information									
Package	Tape Width	Pitch		Reel	Size	5 5 15 1: 0 ::			
	Раскаде	(mm)	mm	inch	mm	inch	Per Reel Packing Quantity		
SOT-23	8	4 ± 0.1	0.157 ± 0.004	178	7	3,000			

Marking information

- " NE1 " = Part No.
- " " = HAF (Halogen and Antimony Free)
- " YM " = Date Code Marking
- " Y " = Year
- " M " = Month

Font type: Arial



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